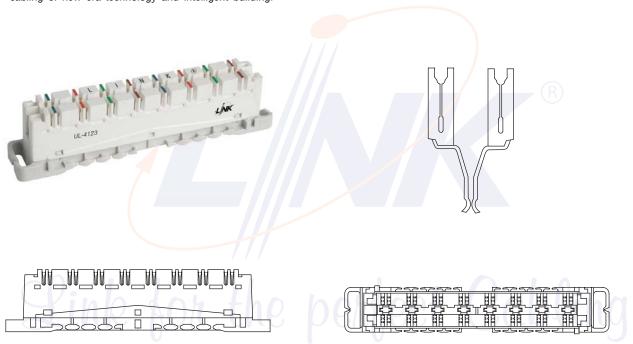
INTELLIGENT DISCONNECTION MODULE 8 PAIRS

Intelligent Disconnection modules are special design suitable for high data rates transmission of MDF (Main Distribution Frames), TC (Telephone Cabinet), CCC (Cross-connection Cabinet) for mounting on BMF (Back Mount Frame) as well as for Structured cabling of new era technology and intelligent building.



FEATURE

- Meets ANSI/TIA/EIA 568-B2.1 Category 6 Performance and ISO11801
- Support all Analog, Digital, Data communication.
- Easy to terminate and Quick mounting on back mount frames in cabinet or main distribution open frame or
 19" rack system.
- IDC (Insulation Displacement Connection) connects wires without solder, screws or removing the insulation.
- Cross Connection can be either patch cord or jumper wire

TECHNICAL DATA

Housing Material : PBT (Thermo-engineering plastic) UL94V-0 flammability self-extinguishing

Colour : White

Size in mm. : w122.5 x d22 x H31

Contact : Special Brass with \geq 5 μ m siver-plated

Wire dimeter in mm.: 0.40 - 0.80 (26-20 AWG) and 0.70 - 1.60 overall insulation diameter

No. of reterminations $\qquad \qquad \geq 200 \ (\geq 1000 \ \text{of patching cycles})$

Termination Type : Insulation Displacement 45°

 $\begin{array}{lll} \mbox{Insulation resistance} & : & \geq 5 \ x \ 10^4 \ M\Omega \\ \mbox{Contact resistance} & : & \leq 10 \ m\Omega \end{array}$

Dielectric Strenth : 2 kVrms or 2 Kveff (50 Hz)

Operating Temperature : $-40 \, \text{C}^{\circ}$ to $80 \, \text{C}^{\circ}$

